



Low-Resistance Molded Inductor 0.56µH

APPLICATIONS



- Battery-powered devices
- Embedded computing
- High-current SMPS
- High-frequency SMPS
- POL converters
- FPGA

FEATURES

- Size 5.5mmx5.3mmx2.9mm
- Low DCR
- Low AC Losses
- Low Audible Noise
- Molded Construction
- Soft Saturation
- Stable Over High Temperatures
- Max Operating Temp +155°C
- RoHS/REACH-Compliant, Halogen-Free

ELECTRICAL CHARACTERISTICS				
Parameter			Value	Unit
Inductance (1)	L	±20%	0.56	μH
Resistance	RDC	typ	3.92	mΩ
Resistance MAX	RDC MAX	max	4.55	$\boldsymbol{m}\boldsymbol{\Omega}$
Rated Current (2)	I _R	typ	13.2	Α
Saturation Current 25°C (3)	ISAT 25°C	typ	22	Α
Saturation Current 100°C (4)	ISAT 100°C	typ	22	Α
Resonance Frequency	fr	typ	67	MHz

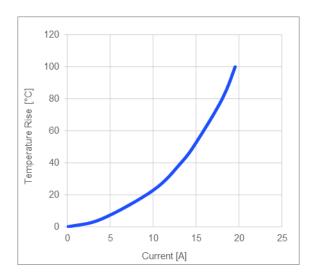
GENERAL SPECIFICATION	IS Control of the con
(1) Inductance	Measured at 100kHz, 100mA
(2) Rated Current	Rated current will cause the coil temperature rise ΔT of 40K I_R measured with the inductor soldered in a single-layer PCB. Copper layer thickness 35 μ m Cu / PCB size 30x50mm. Temperature behavior dependent on circuit design, PCB layout, proximity to other components, and trace dimensions and thickness.
(3) Saturation Current 25°C	Saturation current will cause L to drop from 30% at 25°C ambient temperature
(4) Saturation Current 100°C	Saturation current will cause L to drop from 30% at 100°C ambient temperature
Temperature Test Condition	Electrical specifications measured at 25°C, 35% RH if not given differently
Operating Condition	Operating temperature: -40°C to +155°C (including temp rise)
	Should not exceed +155°C under worst-case operation conditions
Storage Condition	Tape and Reel packaging: -10°C to +40°C
	Humidity: <50% RH

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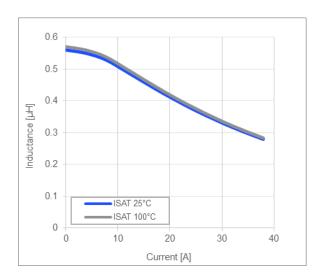


TYPICAL PERFORMANCE CURVES

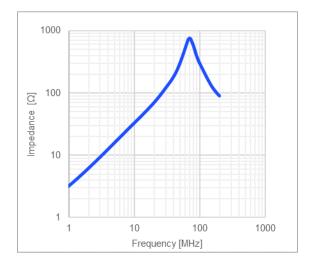
Temperature Rise vs. Current



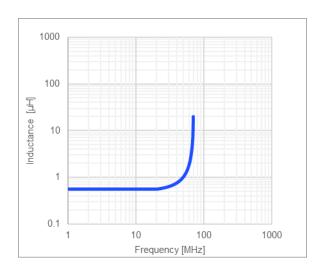
Inductance vs. Current



Impedance vs. Frequency

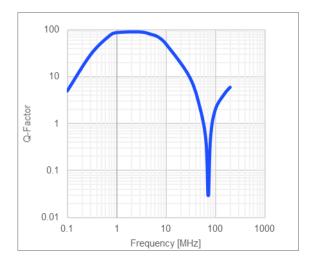


Inductance vs. Frequency

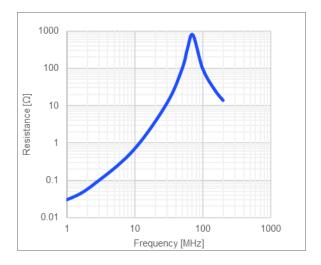




Quality Factor vs. Frequency

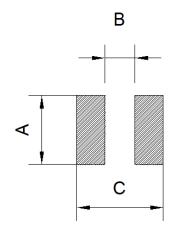


AC Resistance vs. Frequency





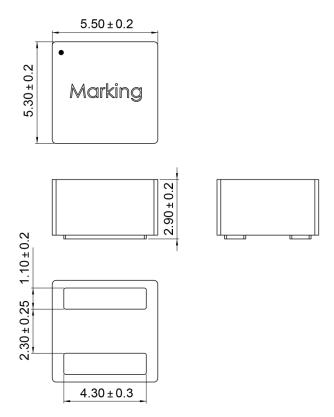
LAND PATTERN		
Dimensions		
Α	4.70 ref.	
В	2.0 ref.	
С	4.50 ref.	
	(unit in mm)	



PRODUCT PACKAGE AND DIMENSIONS

Dimensions

(unit in mm)



TOP MARKING		
Marki	ng	
Start of Winding	· (dot)	
Inductance Code	R56	
MPS Code	MPS	



ORDERING INFORMATION					
Part Number	L (1)	RDC	I _R ⁽²⁾	I SAT 25°C ⁽³⁾	I SAT 100°C ⁽⁴⁾
	typ (µH)	typ (mΩ)	typ (A)	typ (A)	typ (A)
MPL-AL5030-R47	0.47	3.78	13.6	26.5	26.5
MPL-AL5030-R56	0.56	3.92	13.2	22	22
MPL-AL5030-R82	0.82	5.0	12.8	18	18
MPL-AL5030-1R0	1.0	6.5	11.2	16	16
MPL-AL5030-1R2	1.2	8.0	10.0	14	14
MPL-AL5030-1R5	1.5	9.7	9.0	12.5	12.5
MPL-AL5030-1R8	1.8	10.5	8.8	12	12
MPL-AL5030-2R2	2.2	12.3	8.2	11	11
MPL-AL5030-3R3	3.3	21	6.0	10	10
MPL-AL5030-4R7	4.7	33	5.3	8	8

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